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Rashkovsky et al.

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(54) **WAFER CARRIER WITH A 33-POCKET CONFIGURATION**

37/04; B24B 37/32; B24B 57/02; B24B 53/017; B24B 41/061

See application file for complete search history.

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(52) **U.S. Cl.**
USPC **D13/182**

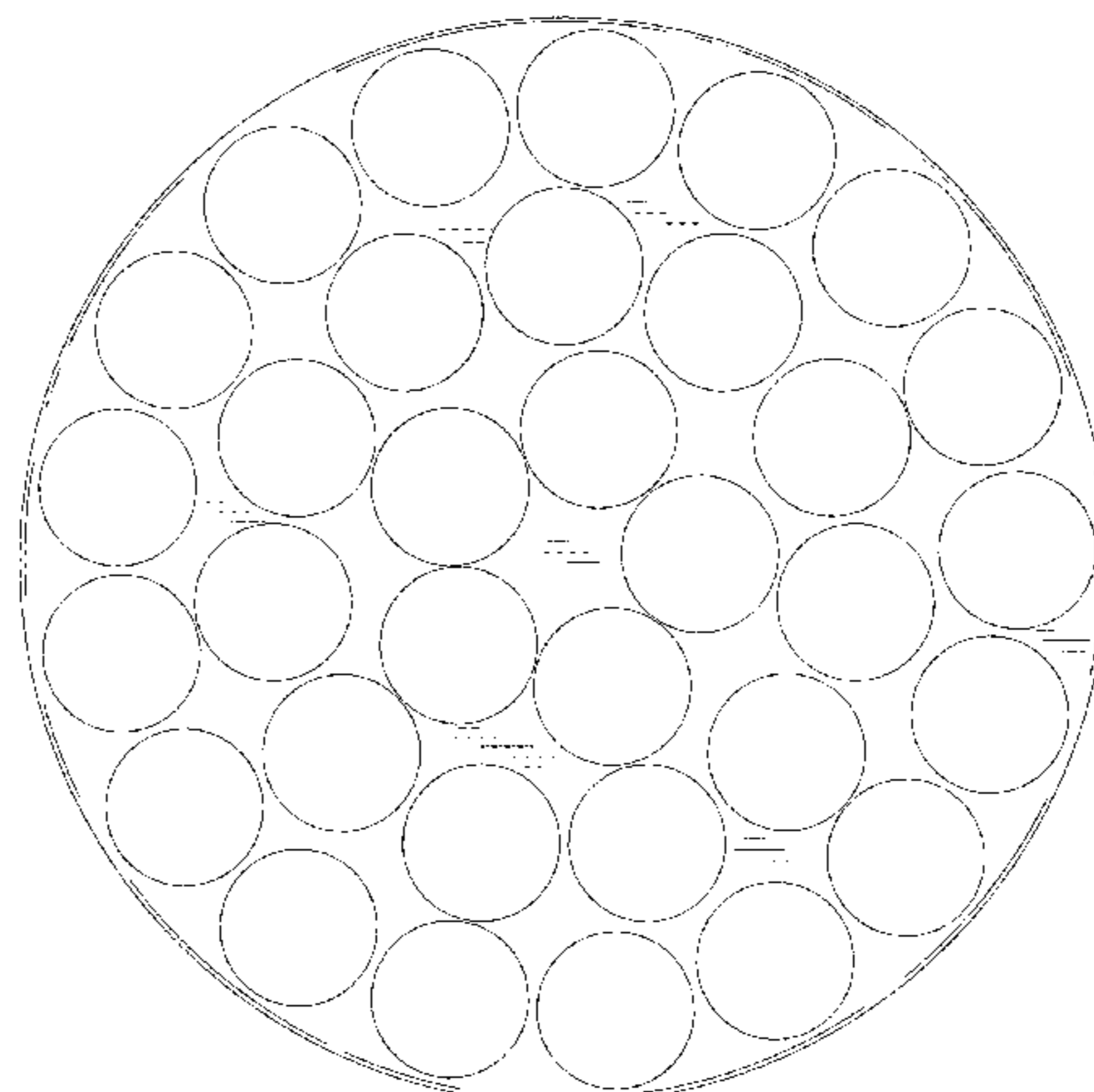
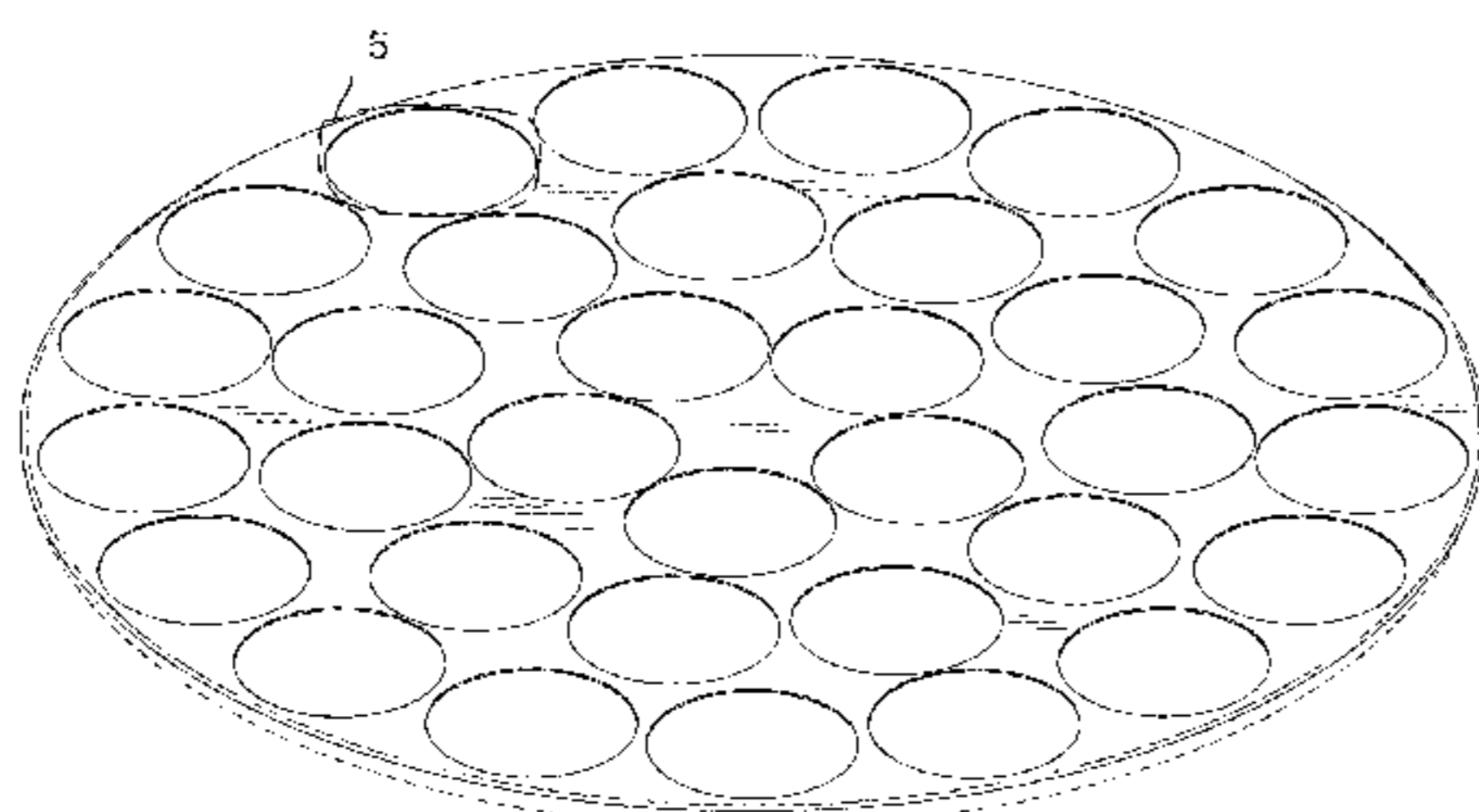
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CPC . B05B 13/0285; B05B 13/0292; B05B 13/02; B05B 13/0228; C23C 14/50; C23C 14/505; C23C 16/4585; C23C 16/4576; C23C 16/4561; C23C 16/4583; C23C 16/4584; B05C 13/00; H01L 21/6838; H01L 21/68771; H01L 21/68735; H01L 21/67103; H01L 21/67051; H01L 21/6708; H01L 21/68785; H01L 21/6831; H01L 21/6833; H01L 21/67109; B23B 31/28; B23Q 3/154; B23Q 3/1546; G03F 7/70708; B24B 37/30; B24B 37/26; B24B

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(57) **CLAIM**

The ornamental design for a wafer carrier with a 33-pocket configuration, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a wafer carrier with a 33-pocket configuration, showing our new design.

FIG. 2 is a top plan view thereof.

FIG. 3 is a bottom plan view thereof.

FIG. 4 is a right side view thereof, with the left side view, front view, and rear view being identical; and,

FIG. 5 is an enlarged portion view taken from encircled portion labeled FIG. 5 in FIG. 1.

In each of the figures, portions or features shown in even broken lines form no part of the claimed design. The dashed-dot lines depict the boundary of the enlarged portion view of FIG. 5, and form no part of the claimed design

1 Claim, 5 Drawing Sheets

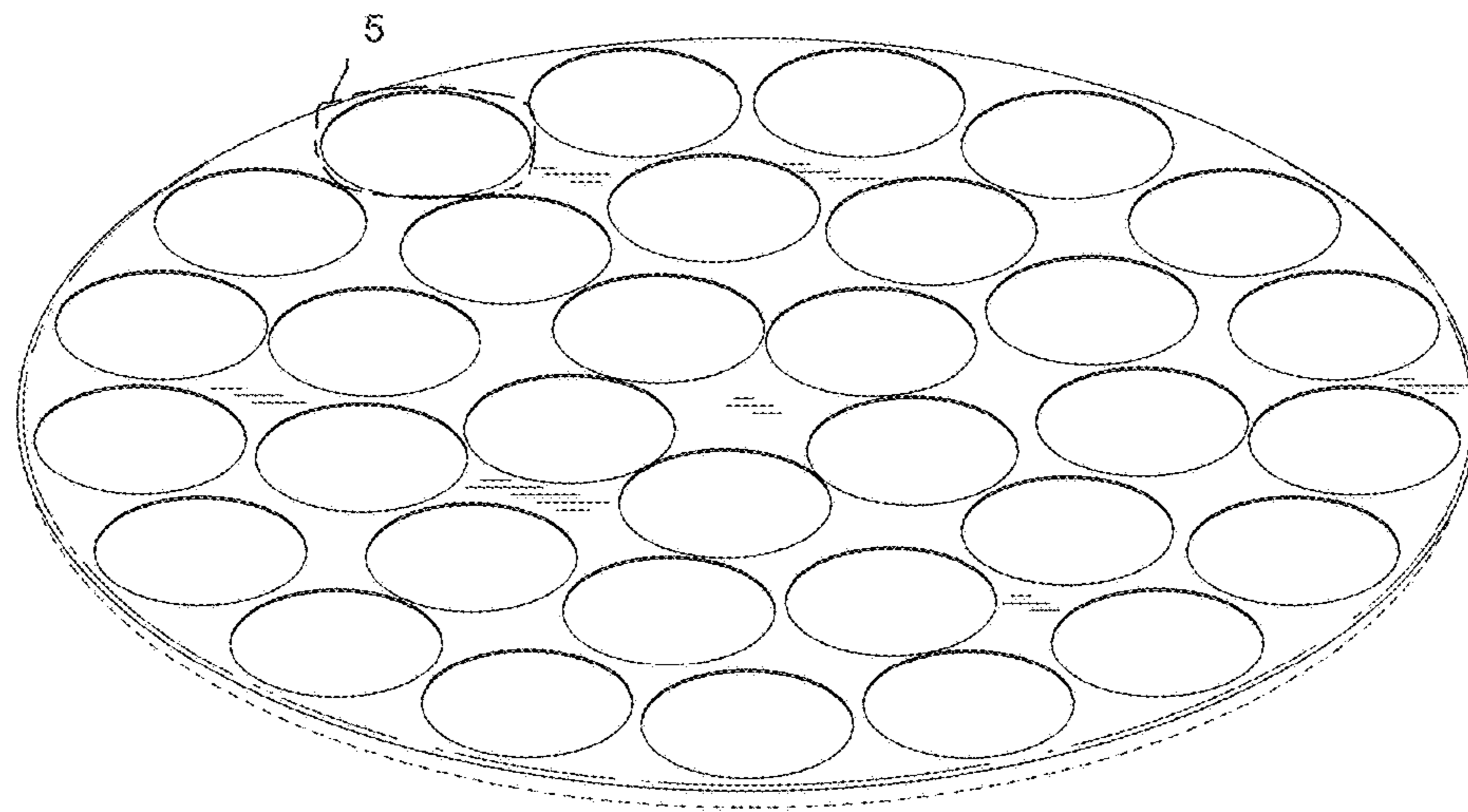


FIG. 1

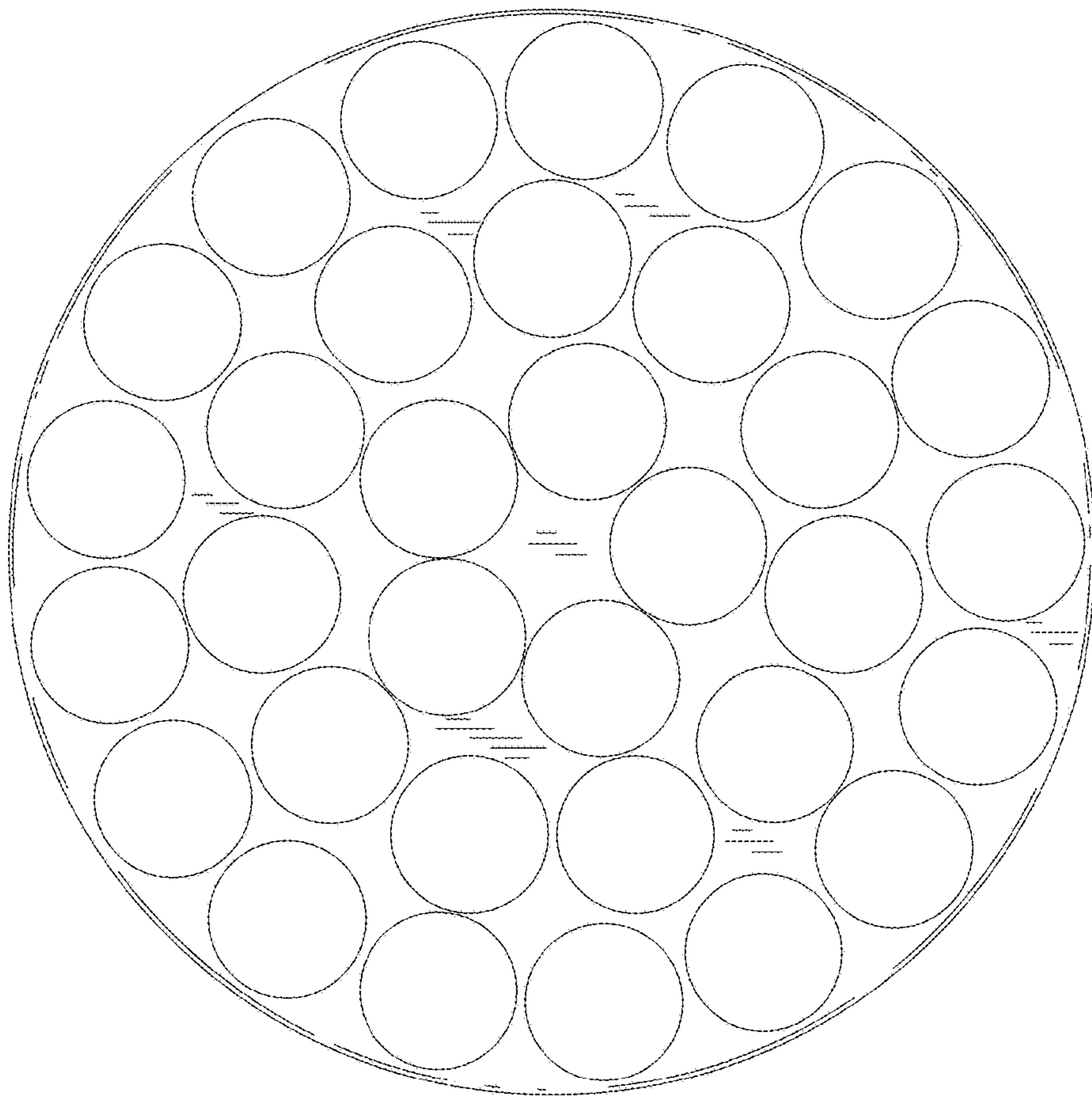


FIG. 2

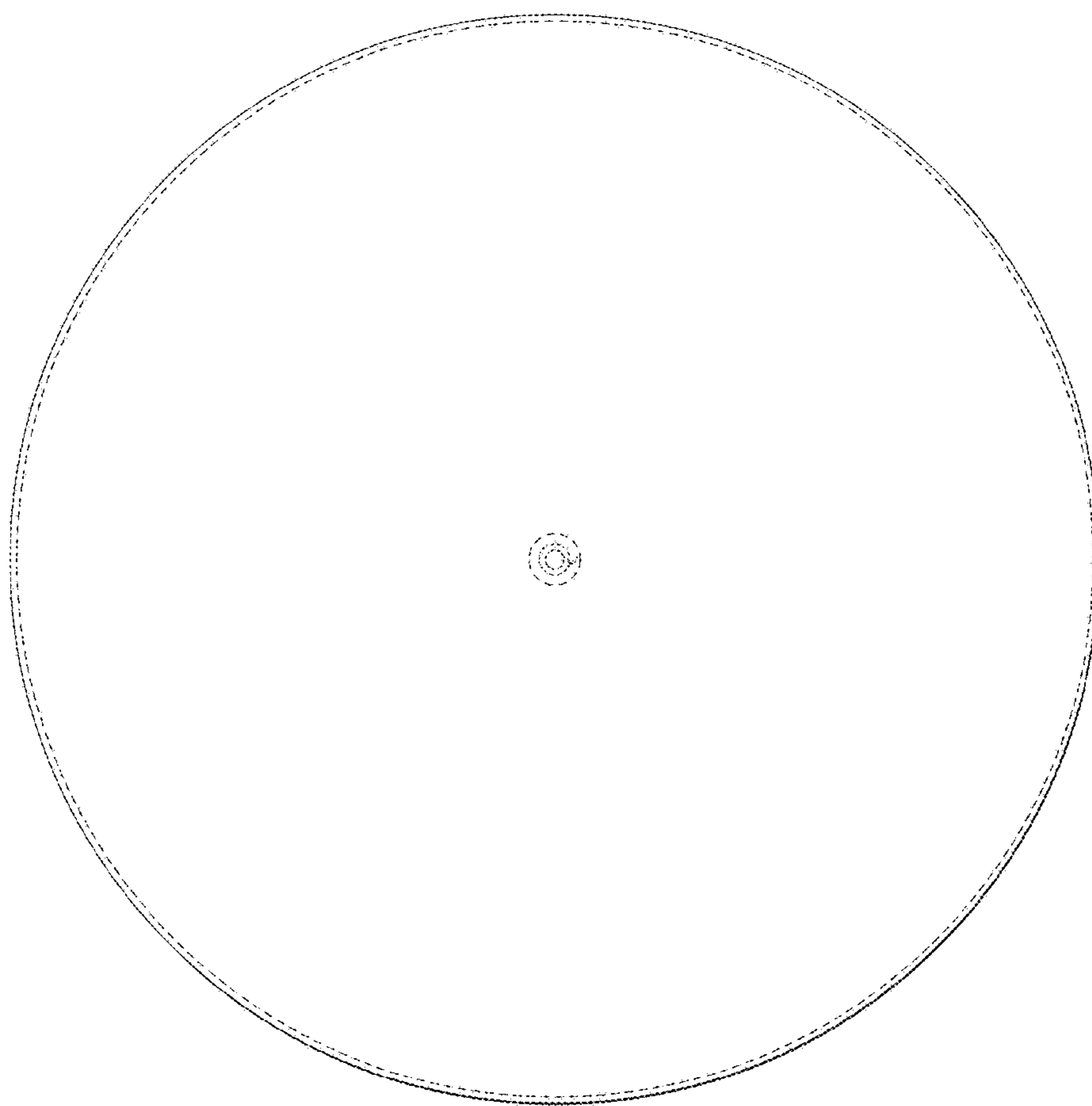


FIG. 3

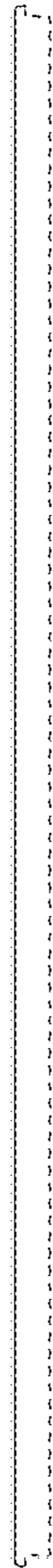


FIG. 4

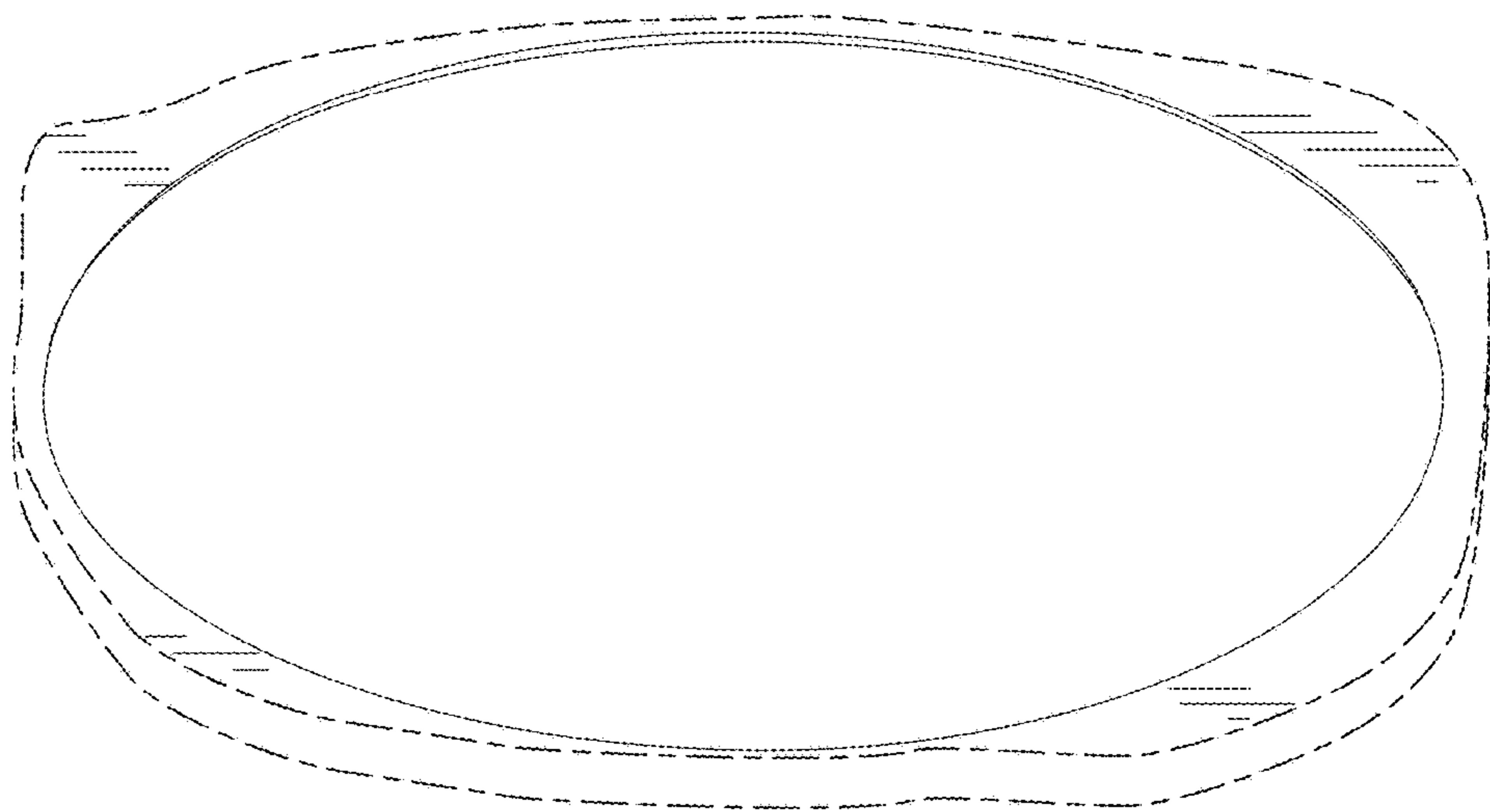


FIG. 5